

MULTILAYER CHIP BEAD HFB SERIES

COMPONENT

PRODUCT IDENTIFICATION

FERRITE CHIP BEAD FOR HIGH FREQ. APPLICATION



HFB 1608 V - 471
A B C D

- A : Series
- B : Dimension (A*B)
- C : Material (Lead Free)
- D : Impedance (601 = 600Ω)

APPLICATIONS

1. Interface line of computer that has high-speed CPU & high-speed bus and other digital equipment.
2. Telecommunication equipment and choke for power supply.
3. Car navigation.
4. Suitable for noise suppression from 500 MHz to GHz range.

SHAPES & DIMENSIONS

Part No.	Z (Ω)	Test Freq. (MHz)	IDC (mA) Max.	RDC (Ω) Max.	Operating Temp. Range(°C)
HFB1608V-471	470±25%	100	200	0.65	-55 to +125
HFB1608V-601	600±25%	100	200	0.85	-55 to +125
HFB1608V-102	1000±25%	100	100	1.20	-55 to +125

· TYPICAL IMPEDANCE V.S. FREQUENCY CURVE

